



- NOTES:
- MATERIAL:
    - HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL 94V-0 RATED, BLACK
    - CONTACT: COPPER ALLOY
    - SHELL: COPPER ALLOY/SPCC
  - PLATING:
    - CONTACT: GOLD PLATED OVER NICKEL
    - SHELL: NICKEL PLATED
  - P/N: HHF-33X000-XSB
- TERMINAL PLATING CODE: \_\_\_\_\_ REV. CODE \_\_\_\_\_
- A: CONTACT AREA: GOLD FLASH  
 SOLDER AREA: MATTE TIN 100u"  
 B: CONTACT AREA: 3u" GOLD  
 SOLDER AREA: MATTE TIN 100u"  
 C: CONTACT AREA: 15u" GOLD  
 SOLDER AREA: MATTE TIN 100u"

**RECOMMENDED PCB LAYOUT THICKNESS = 1.6 mm**  
**TOLERANCE = ±0.05**  
**(TOP VIEW)**

MATERIAL	TOLERANCE UNSPECIFIED	鉍創科技有限公司		
	0.0 ±0.30 0' ±2'	TRONTEK TECHNOLOGY CO., LTD.		
FINISH	0.00 ±0.20 0' ±1'	SCALE	UNIT	
	0.000 ±0.10 0' ±0.5'	1:1	mm	
	DRAWN 孙洪桥 09/05/25	NAME		SHEET
		HDMI A/F 朝天式 SMT TYPE		1/2
CHECKED 孙洪桥 09/05/25	DRAWING NO.		REV	
APPROVED	HHF-33X000-XSB		A	

A	新版发行	chu	2010-12-05
Rev. 版本	CHANGE DESCRIPTION 变更内容	REVISOR 制/修订人	DATE 日期